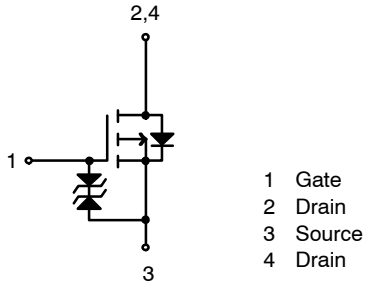
MOSFET – Power, P-Channel, Single ATPAK

-60 V, -35 A, 29.5 mΩ

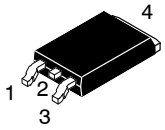
ATP113

Features

- ON−Resistance $R_{DS(on)}1$ = 22.5 mΩ (typ)
- 4 V Drive
- Protection Diode in
- Input Capacitance Ciss = 2400 pF (typ)
- This Device is a Pb−Free and Halogen Free



ELECTRICAL CONNECTION



DPAK (Single Gauge) / ATPAK
CASE 369AM

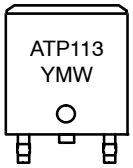
ABSOLUTE MAXIMUM RATINGS (Ta = 25°C) (Note 1)

Parameter	Symbol	Conditions	Value	Unit
Drain−to−Source Voltage	V_{DSS}		−60	V
Gate−to−Source Voltage	V_{GSS}		±20	V
Drain Current (DC)	I_D		−35	A
Drain Current (PW ≤ 10 μs)	I_{DP}	PW ≤ 10 μs, duty cycle ≤ 1%	−105	A
Allowable Power Dissipation	P_D	Tc = 25°C	50	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		−55 to +150	°C
Avalanche Energy (Single Pulse) (Note 1)	E_{AS}		95	mJ
Avalanche Current (Note 2)	I_{AV}		−18	A

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V_{DD} = −10 V, L = 500 μH, I_{AV} = −18 A
2. L ≤ 500 μH, Single pulse

MARKING DIAGRAM



ATP113 = Specific Device Code
Y = Year of Production
M = Assembly Operation Month
W = Work Week in the Month

ORDERING INFORMATION

Device	Package	Shipping†
ATP113−TL−H	DPAK / ATPAK (Pb−Free and Halide Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Value			Unit
			Min	Typ	Max	
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	I_D = −1 mA, V_{GS} = 0 V	−60	–	–	V
Zero−Gate Voltage Drain Current	I_{DSS}	V_{DS} = −60 V, V_{GS} = 0 V	–	–	−1	μA
Gate to Source Leakage Current	I_{GSS}	V_{GS} = +16 V, V_{DS} = 0 V	–	–	+10	μA
Cutoff Voltage	V_{GS}(off)	V_{DS} = −10 V, I_D = −1 mA	−1.2	–	−2.6	V
Forward Transfer Admittance	|yfs|	V_{DS} = −10 V, I_D = −18 A	–	37	–	S
Static Drain to Source On−State Resistance	R_{DS}(on)1	I_D = −18 A, V_{GS} = −10 V	–	22.5	29.5	mΩ
	R_{DS}(on)2	I_D = −9 A, V_{GS} = −4.5 V	–	27	38	mΩ
	R_{DS}(on)3	I_D = −5 A, V_{GS} = −4 V	–	29	44	mΩ
Input Capacitance	Ciss	V_{DS} = −20 V, f = 1 MHz	–	2400	–	pF
Output Capacitance	Coss		–	250	–	pF
Reverse Transfer Capacitance	Crss		–	195	–	pF
Turn−ON Delay Time	t_d(on)	See specified Test Circuit.	–	15	–	ns
Rise Time	t_r		–	125	–	ns
Turn−OFF Delay Time	t_d(off)		–	250	–	ns
Fall Time	t_f		–	200	–	ns
Total Gate Charge	Qg	V_{DS} = −30 V, V_{GS} = −10 V, I_D = −35 A	–	55	–	nC
Gate to Source Charge	Qgs		–	7.5	–	nC
Gate to Drain “Miller” Charge	Qgd		–	12	–	nC
Diode Forward Voltage	V_{SD}	I_S = −35 A, V_{GS} = 0 V	–	−0.98	−1.5	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Switching Time Test Circuit

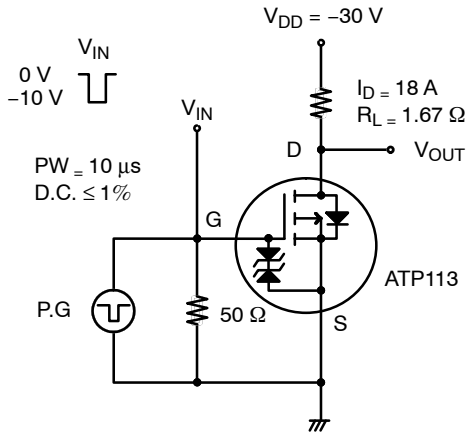

Figure 1. Switching Time Test Circuit

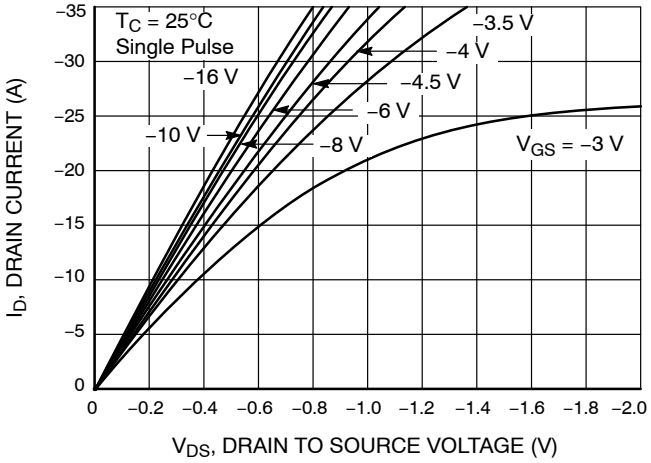

Figure 2. I_D – V_{DS}

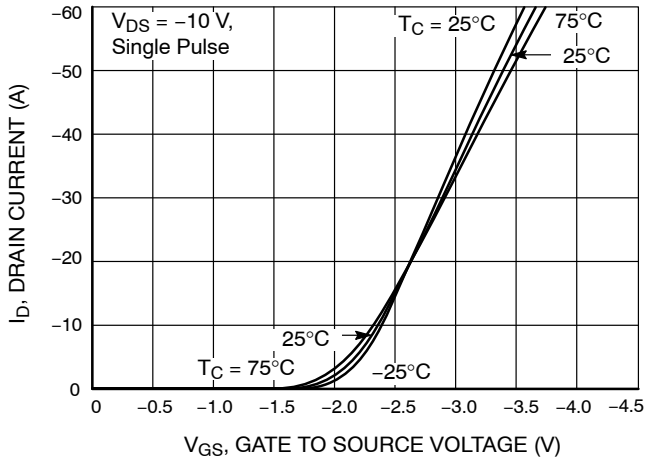

Figure 3. I_D – V_{GS}

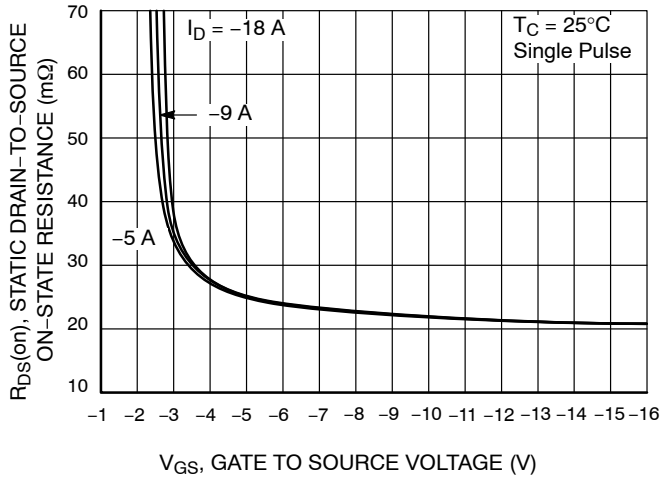

Figure 4. $R_{DS}(on)$ – V_{GS}

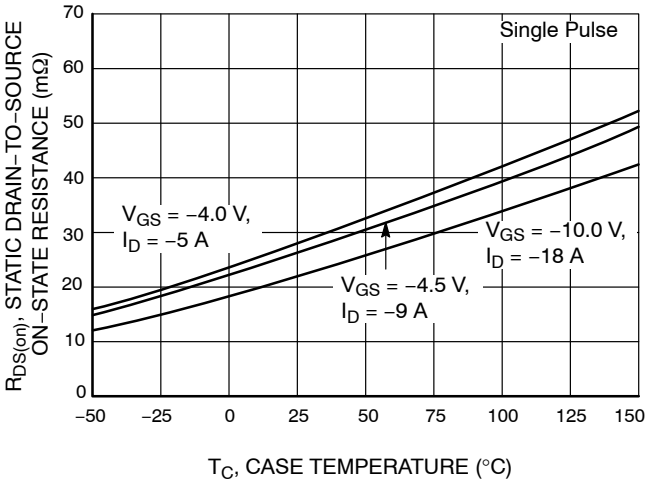

Figure 5. $R_{DS}(on)$ – T_C

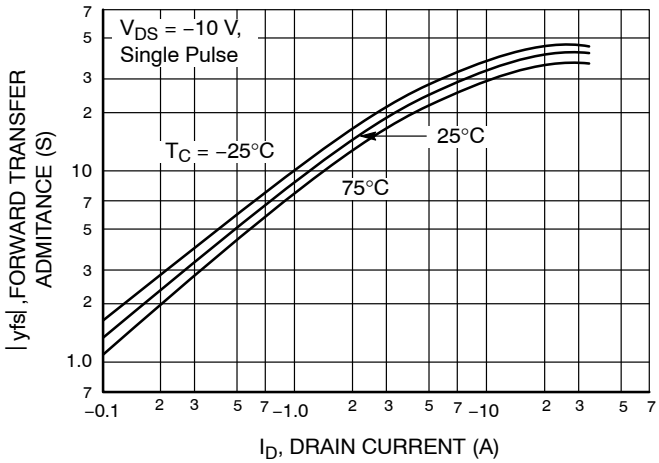

Figure 6. | yfs | – I_D

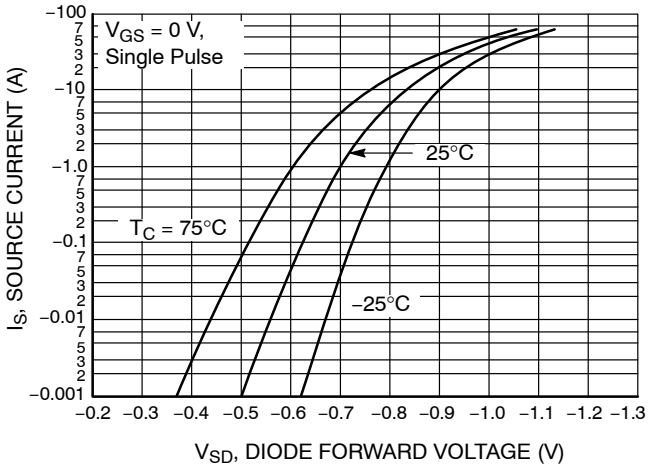

Figure 7. I_S – V_{SD}

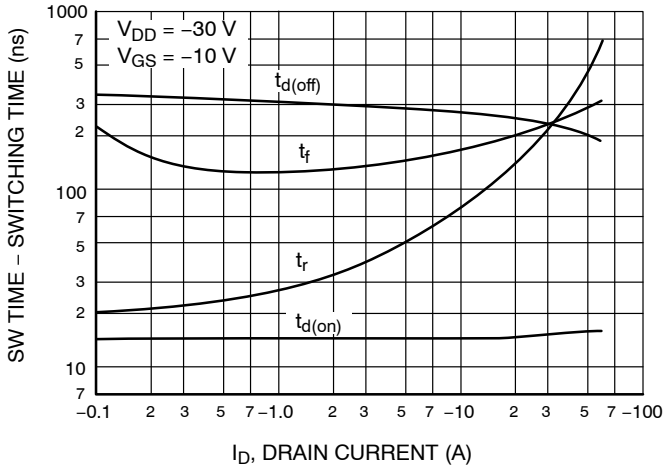

Figure 8. SW Time – I_D

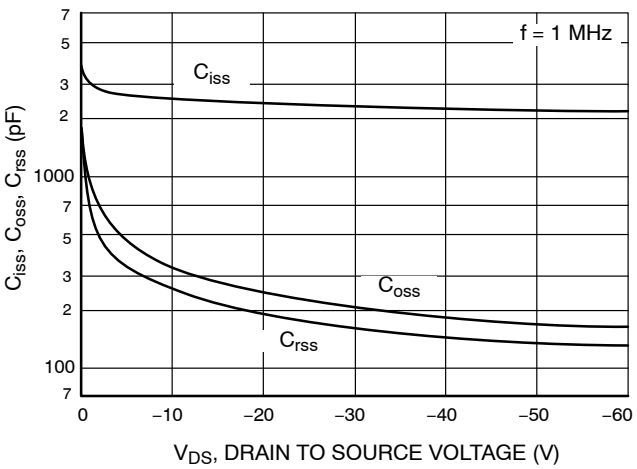

Figure 9. C_{iss}, C_{oss}, C_{rss} – V_{DS}

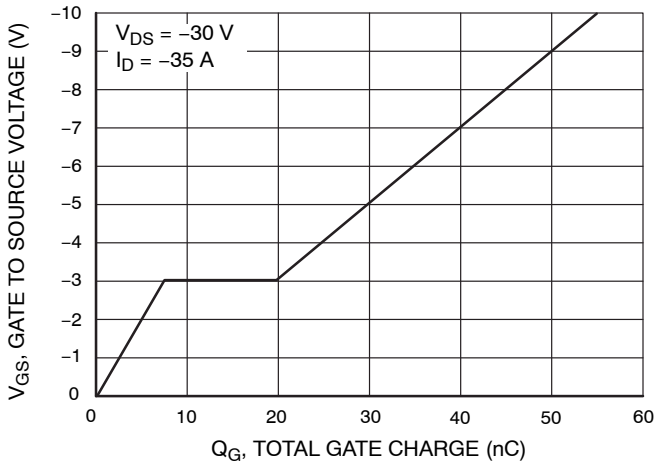

Figure 10. V_{GS} – Q_g

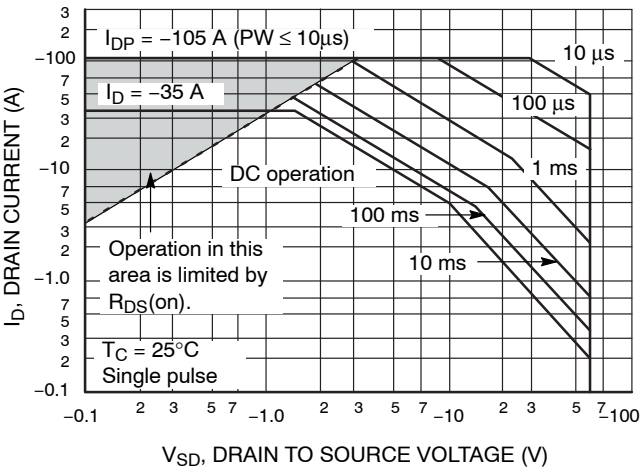

Figure 11. ASO

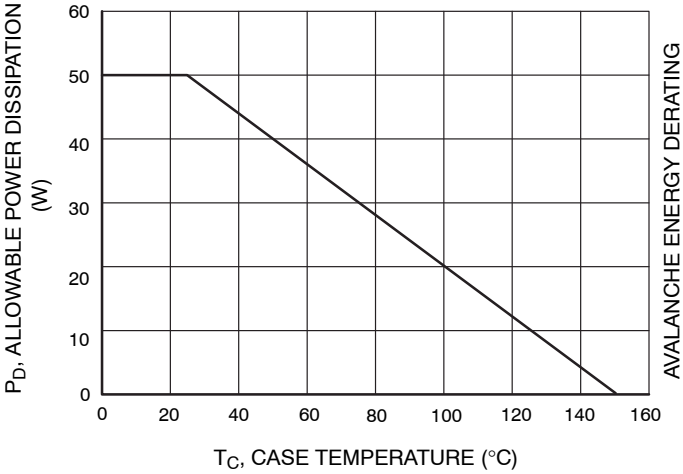

Figure 12. P_D – T_C

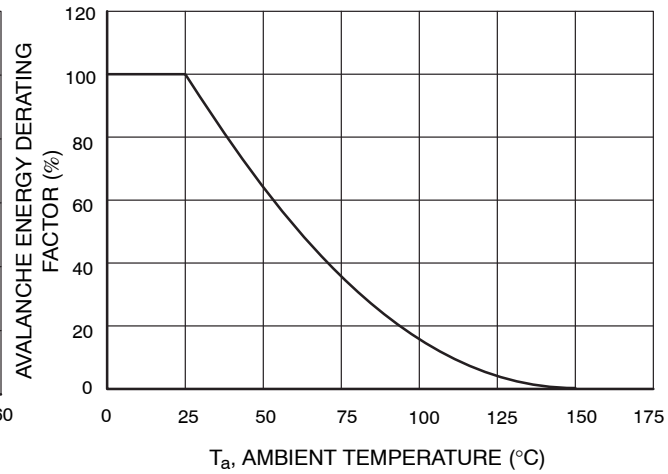

Figure 13. E_{AS} – T_a

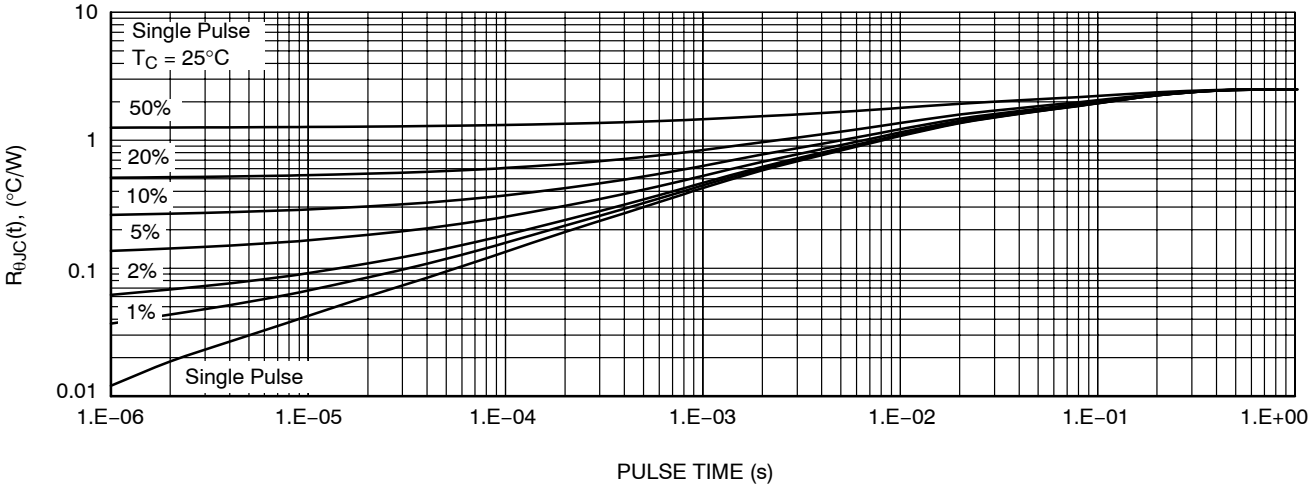

Figure 14. Thermal Response

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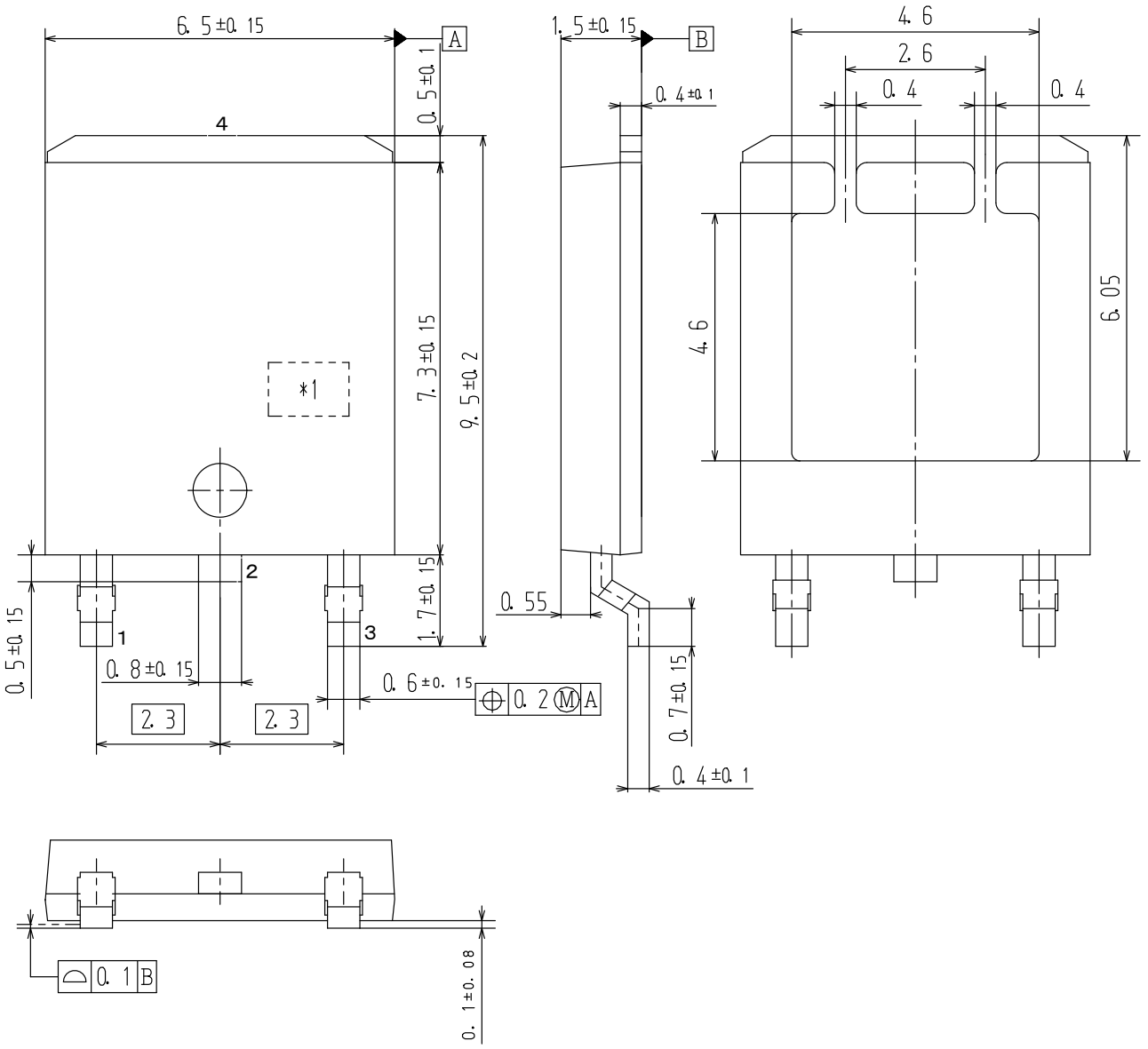
DATE 29 FEB 2012



Pin2 is idle pin with electrical designation only carried

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